

16. The plastic layer according to claim 15, wherein the plastic layer comprises basic polymers having properties that are modified to form the release properties.

17. The plastic layer according to claim 15, wherein the materials having the release properties are incorporated into the plastic layer as additives and comprise silicone compounds.

18. The plastic layer according to claim 15, wherein the materials incorporated as additives comprise polyolefin compounds.

19. The plastic layer according to claim 15, wherein the materials having the release properties are firmly embedded into a matrix of the plastic layer.

20. The plastic layer according to claim 15, wherein the materials having the release properties comprise inorganic fillers.

21. The plastic layer according to claim 15, wherein the plastic layer further comprises a carrier layer.

22. The plastic layer according to claim 15, wherein the thickness of the plastic layer is about 5 μm .

23. A method of making a plastic layer having an adhesive layer and a release layer, comprising the steps of:

 adding materials containing release properties to the plastic layer; and

 polymerizing the materials containing release properties into the plastic layer.

*Bl
B1
Coated*

24. The method according to claim 23, further comprising the step of extruding the plastic layer onto a substrate layer.

25. The method according to claim 23, further comprising the step of producing the plastic layer from a master batch.

26. The method according to claim 23, further comprising the step of co-extruding the plastic layer.

27. The method according to claim 23, further comprising the step of extruding the plastic layer with a plastic carrier layer.

C1 canceled
28. The method according to claim 27, further comprising
the step of extruding the plastic layer onto a carrier web.

*B1
B2
B3
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B5
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B7*
29. The method according to claim 23, further comprising
the step of embossing the plastic layer.

*B1
B2
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B7*
30. The method according to claim 27, further comprising
the step of embossing said carrier layer.

*Sub
SC2*
31. A plastic layer having a first side and a second side,
comprising:
a release layer embedded in the first side of the
plastic layer before extrusion, wherein said release layer is
selected from the group consisting of a modified polymer, a
silicone compound and a polyolefin additive; and
an adhesive layer disposed on the second side of the
plastic layer.--

REMARKS

The Applicant submits that the application is in condition
for allowance in view of the above amendments and the following
remarks. Claims 1-14 have been canceled, claims 15-31 have been
added. No new matter has been added.